

Important notice

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Kind regards,

Team Nexperia



MMBZxAL series

Low capacitance unidirectional double ESD protection diodes Rev. 02 — 10 December 2009 Product data sheet

Product profile

1.1 General description

Unidirectional double ElectroStatic Discharge (ESD) protection diodes in a common anode configuration, encapsulated in a SOT23 (TO-236AB) small Surface-Mounted Device (SMD) plastic package. The devices are designed for ESD and transient overvoltage protection of up to two signal lines.

Table 1. **Product overview**

Type number	Package		Configuration	
	NXP	JEDEC		
MMBZ5V6AL	SOT23	TO-236AB	dual common anode	
MMBZ6V2AL				
MMBZ6V8AL				
MMBZ9V1AL				
MMBZ10VAL				
MMBZ12VAL				
MMBZ15VAL				
MMBZ18VAL				
MMBZ20VAL				
MMBZ27VAL				
MMBZ33VAL				

1.2 Features

- Unidirectional ESD protection of two lines
- Bidirectional ESD protection of one line IEC 61000-4-2; level 4 (ESD)
- Low diode capacitance: C_d ≤ 280 pF
- Rated peak pulse power: P_{PPM} = 40 W
- Ultra low leakage current: I_{RM} = 5 nA
- ESD protection up to 30 kV (contact) discharge)
- IEC 61643-321
- AEC-Q101 qualified

1.3 Applications

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- Automotive electronic control units
- Portable electronics



1.4 Quick reference data

Table 2. Quick reference data

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode	Э					
V_{RWM}	reverse standoff voltage					
	MMBZ5V6AL		-	-	3	V
	MMBZ6V2AL		-	-	3	V
	MMBZ6V8AL		-	-	4.5	V
	MMBZ9V1AL		-	-	6	V
	MMBZ10VAL		-	-	6.5	V
	MMBZ12VAL		-	-	8.5	V
	MMBZ15VAL		-	-	12	V
	MMBZ18VAL		-	-	14.5	V
	MMBZ20VAL		-	-	17	V
	MMBZ27VAL		-	-	22	V
	MMBZ33VAL		-	-	26	V
C _d	diode capacitance	$f = 1 MHz; V_R = 0 V$				
	MMBZ5V6AL		-	210	280	pF
	MMBZ6V2AL		-	175	230	pF
	MMBZ6V8AL		-	150	200	pF
	MMBZ9V1AL		-	155	200	pF
	MMBZ10VAL		-	130	170	pF
	MMBZ12VAL		-	110	140	pF
	MMBZ15VAL		-	85	105	pF
	MMBZ18VAL		-	70	90	pF
	MMBZ20VAL		-	65	80	pF
	MMBZ27VAL		-	48	60	pF
	MMBZ33VAL		-	45	55	pF

2. Pinning information

Table 3. Pinning

Table 3.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	cathode (diode 1)	—-	
2	cathode (diode 2)	3	[3]
3	common anode	1 2	1 2 006aaa154

3. Ordering information

Table 4. Ordering information

Type number	Package					
	Name	Description	Version			
MMBZ5V6AL	-	plastic surface-mounted package; 3 leads	SOT23			
MMBZ6V2AL						
MMBZ6V8AL						
MMBZ9V1AL						
MMBZ10VAL						
MMBZ12VAL						
MMBZ15VAL						
MMBZ18VAL						
MMBZ20VAL						
MMBZ27VAL						
MMBZ33VAL	_					

4. Marking

Table 5. Marking codes

Table 5. Marking codes	
Type number	Marking code ^[1]
MMBZ5V6AL	RR*
MMBZ6V2AL	RS*
MMBZ6V8AL	RT*
MMBZ9V1AL	RU*
MMBZ10VAL	RV*
MMBZ12VAL	*H1
MMBZ15VAL	*H2
MMBZ18VAL	*H3
MMBZ20VAL	*H4
MMBZ27VAL	*H5
MMBZ33VAL	*H6

^{[1] * = -:} made in Hong Kong

^{* =} p: made in Hong Kong

^{* =} t: made in Malaysia

^{* =} W: made in China

5. Limiting values

Table 6. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
P _{PPM}	rated peak pulse power	$t_p = 10/1000 \ \mu s$	[1][2]		
	MMBZ5V6AL	•	-	24	W
	MMBZ6V2AL				
	MMBZ6V8AL				
	MMBZ9V1AL				
	MMBZ10VAL				
	MMBZ12VAL		-	40	W
	MMBZ15VAL				
	MMBZ18VAL				
	MMBZ20VAL				
	MMBZ27VAL				
	MMBZ33VAL				
I _{PPM}	rated peak pulse current	$t_p = 10/1000 \ \mu s$	[1][2]		
	MMBZ5V6AL		-	3	Α
	MMBZ6V2AL		-	2.76	Α
	MMBZ6V8AL		-	2.5	Α
	MMBZ9V1AL		-	1.7	Α
	MMBZ10VAL		-	1.7	Α
	MMBZ12VAL		-	2.35	Α
	MMBZ15VAL		-	1.9	Α
	MMBZ18VAL		-	1.6	Α
	MMBZ20VAL		-	1.4	Α
	MMBZ27VAL		-	1	Α
	MMBZ33VAL		-	0.87	Α
Per device					
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$			
	MMBZxAL series		[3] _	265	mW
	MMBZ5V6AL		[4] _	290	mW
	MMBZ6V2AL				
	MMBZ6V8AL				
	MMBZ9V1AL		<u>[4]</u> _	360	mW
	MMBZ10VAL				
	MMBZ12VAL				
	MMBZ15VAL				
	MMBZ18VAL				
	MMBZ20VAL				
	MMBZ27VAL				
	MMBZ33VAL				

5 of 17

Low capacitance unidirectional double ESD protection diodes

Table 6. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		–55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

- [1] In accordance with IEC 61643-321 (10/1000 μs current waveform).
- [2] Measured from pin 1 or 2 to pin 3.
- [3] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

Table 7. ESD maximum ratings

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V_{ESD}	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	[1][2] -	30	kV
		machine model	[2] _	2	kV

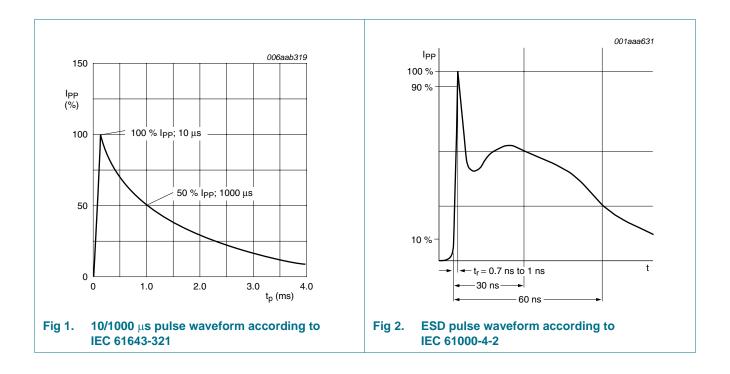
- [1] Device stressed with ten non-repetitive ESD pulses.
- [2] Measured from pin 1 or 2 to pin 3.

Table 8. ESD standards compliance

Standard	Conditions
Per diode	
IEC 61000-4-2; level 4 (ESD)	> 15 kV (air); > 8 kV (contact)
MIL-STD-883; class 3 (human body model)	> 8 kV

MMBZxAL series

Low capacitance unidirectional double ESD protection diodes



Thermal characteristics

Table 9.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per device	ce					
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air				
	MMBZxAL series		[1] -	-	460	K/W
	MMBZ5V6AL		[2] _	-	420	K/W
	MMBZ6V2AL					
	MMBZ6V8AL					
	MMBZ9V1AL		[2]	-	340	K/W
	MMBZ10VAL					
	MMBZ12VAL					
	MMBZ15VAL					
	MMBZ18VAL					
	MMBZ20VAL					
	MMBZ27VAL					
	MMBZ33VAL					
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]			
	MMBZ5V6AL		-	-	150	K/W
	MMBZ6V2AL					
	MMBZ6V8AL					
	MMBZ9V1AL		-	-	50	K/W
	MMBZ10VAL					
	MMBZ12VAL					
	MMBZ15VAL					
	MMBZ18VAL					
	MMBZ20VAL					
	MMBZ27VAL					
	MMBZ33VAL					

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

^[3] Measured from pin 1 or 2 to pin 3.

7. Characteristics

Table 10. Characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

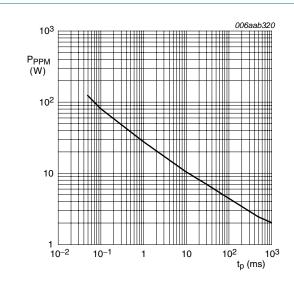
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
V _F	forward voltage	I _F = 10 mA	-	-	0.9	V
V_{RWM}	reverse standoff voltage					
	MMBZ5V6AL		-	-	3	V
	MMBZ6V2AL		-	-	3	V
	MMBZ6V8AL		-	-	4.5	V
	MMBZ9V1AL		-	-	6	V
	MMBZ10VAL		-	-	6.5	V
	MMBZ12VAL		-	-	8.5	V
	MMBZ15VAL		-	-	12	V
	MMBZ18VAL		-	-	14.5	V
	MMBZ20VAL		-	-	17	V
	MMBZ27VAL		-	-	22	V
	MMBZ33VAL		-	-	26	V
I _{RM}	reverse leakage current					
	MMBZ5V6AL	$V_{RWM} = 3 V$	-	0.24	5	μΑ
	MMBZ6V2AL	$V_{RWM} = 3 V$	-	5	200	nA
	MMBZ6V8AL	$V_{RWM} = 4.5 V$	-	10	300	nA
	MMBZ9V1AL	$V_{RWM} = 6 V$	-	5	100	nA
	MMBZ10VAL	$V_{RWM} = 6.5 V$	-	1	20	nA
	MMBZ12VAL	$V_{RWM} = 8.5 V$	-	0.1	5	nA
	MMBZ15VAL	V _{RWM} = 12 V	-	0.1	5	nA
	MMBZ18VAL	V _{RWM} = 14.5 V	-	0.1	5	nA
	MMBZ20VAL	V _{RWM} = 17 V	-	0.1	5	nA
	MMBZ27VAL	V _{RWM} = 22 V	-	0.1	5	nA
	MMBZ33VAL	V _{RWM} = 26 V	-	0.1	5	nA
V_{BR}	breakdown voltage					
	MMBZ5V6AL	$I_R = 20 \text{ mA}$	5.32	5.6	5.88	V
	MMBZ6V2AL	I _R = 1 mA	5.89	6.2	6.51	V
	MMBZ6V8AL	I _R = 1 mA	6.46	6.8	7.14	V
	MMBZ9V1AL	I _R = 1 mA	8.65	9.1	9.56	V
	MMBZ10VAL	I _R = 1 mA	9.5	10	10.5	V
	MMBZ12VAL	I _R = 1 mA	11.4	12	12.6	V
	MMBZ15VAL	I _R = 1 mA	14.25	15	15.75	V
	MMBZ18VAL	I _R = 1 mA	17.1	18	18.9	V
	MMBZ20VAL	I _R = 1 mA	19	20	21	V
	MMBZ27VAL	I _R = 1 mA	25.65	27	28.35	V
	MMBZ33VAL	I _R = 1 mA	31.35	33	34.65	V

Table 10. Characteristics ...continued $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _d	diode capacitance	$f = 1 MHz; V_R = 0 V$				
	MMBZ5V6AL		-	210	280	pF
	MMBZ6V2AL		-	175	230	pF
	MMBZ6V8AL		-	150	200	pF
	MMBZ9V1AL		-	155	200	pF
	MMBZ10VAL		-	130	170	pF
	MMBZ12VAL		-	110	140	pF
	MMBZ15VAL		-	85	105	pF
	MMBZ18VAL		-	70	90	pF
	MMBZ20VAL		-	65	80	pF
	MMBZ27VAL		-	48	60	pF
	MMBZ33VAL		-	45	55	pF
V _{CL}	clamping voltage		[1][2]			
	MMBZ5V6AL	$I_{PPM} = 3 A$	-	-	8	V
	MMBZ6V2AL	$I_{PPM} = 2.76 \text{ A}$	-	-	8.7	V
	MMBZ6V8AL	$I_{PPM} = 2.5 A$	-	-	9.6	V
	MMBZ9V1AL	$I_{PPM} = 1.7 A$	-	-	14	V
	MMBZ10VAL	$I_{PPM} = 1.7 A$	-	-	14.2	V
	MMBZ12VAL	$I_{PPM} = 2.35 A$	-	-	17	V
	MMBZ15VAL	$I_{PPM} = 1.9 A$	-	-	21	V
	MMBZ18VAL	I _{PPM} = 1.6 A	-	-	25	V
	MMBZ20VAL	$I_{PPM} = 1.4 A$	-	-	28	V
	MMBZ27VAL	I _{PPM} = 1 A	-	-	40	V
	MMBZ33VAL	$I_{PPM} = 0.87 A$	-	-	46	V
Sz	temperature coefficien	t				
	MMBZ5V6AL	$I_Z = 20 \text{ mA}$	-	1.7	-	mV/l
	MMBZ6V2AL	$I_Z = 1 \text{ mA}$	-	2.1	-	mV/l
	MMBZ6V8AL	$I_Z = 1 \text{ mA}$	-	3.2	-	mV/l
	MMBZ9V1AL	$I_Z = 1 \text{ mA}$	-	5.4	-	mV/l
	MMBZ10VAL	$I_Z = 1 \text{ mA}$	-	6.5	-	mV/l
	MMBZ12VAL	$I_Z = 1 \text{ mA}$	-	8.2	-	mV/l
	MMBZ15VAL	$I_Z = 1 \text{ mA}$	-	11	-	mV/ŀ
	MMBZ18VAL	$I_Z = 1 \text{ mA}$	-	14	-	mV/ł
	MMBZ20VAL	$I_Z = 1 \text{ mA}$	-	15.8	-	mV/ł
	MMBZ27VAL	$I_Z = 1 \text{ mA}$	-	23	-	mV/l
	MMBZ33VAL	I _Z = 1 mA	-	29.8	-	mV/ŀ

^[1] In accordance with IEC 61643-321(10/1000 μs current waveform).

^[2] Measured from pin 1 or 2 to pin 3.



T_{amb} = 25 °C unidirectional and bidirectional

Fig 3. Rated peak pulse power as a function of exponential pulse duration (rectangular waveform); typical values

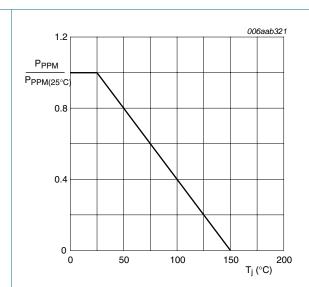
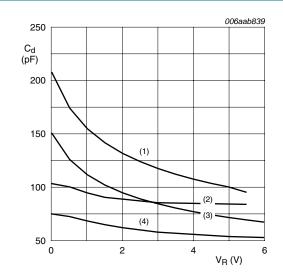


Fig 4. Relative variation of rated peak pulse power as a function of junction temperature; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \,^{\circ}\text{C}$

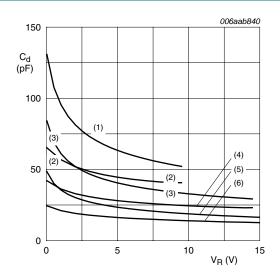
(1) MMBZ5V6AL: unidirectional

(2) MMBZ5V6AL: bidirectional

(3) MMBZ6V8AL: unidirectional

(4) MMBZ6V8AL: bidirectional





 $f = 1 \text{ MHz}; T_{amb} = 25 \,^{\circ}\text{C}$

(1) MMBZ10VAL: unidirectional

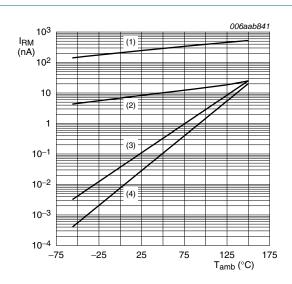
(2) MMBZ10VAL: bidirectional

(3) MMBZ15VAL: unidirectional

(4) MMBZ15VAL: bidirectional(5) MMBZ27VAL: unidirectional

(6) MMBZ27VAL: bidirectional

Fig 6. Diode capacitance as a function of reverse voltage; typical values



(1) MMBZ5V6AL: $V_{RWM} = 3 V$

(2) MMBZ6V8AL: $V_{RWM} = 4.5 \text{ V}$ (3) MMBZ9V1AL: $V_{RWM} = 6 \text{ V}$

(4) MMBZ27VAL: $V_{RWM} = 22 \text{ V}$

Fig 7. Reverse leakage current as a function of ambient temperature; typical values

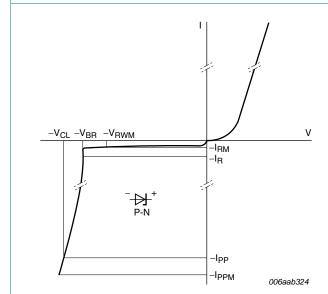


Fig 8. V-I characteristics for a unidirectional ESD protection diode

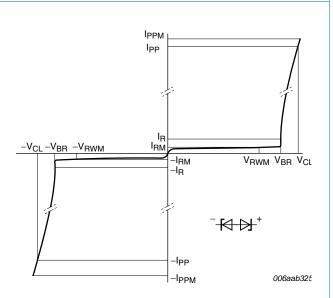
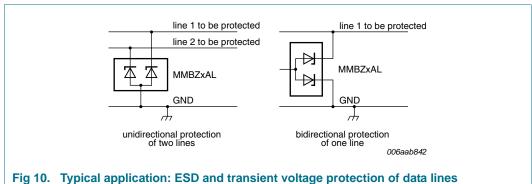


Fig 9. V-I characteristics for a bidirectional ESD protection diode

11 of 17

8. Application information

The MMBZxAL series is designed for the protection of up to two unidirectional data or signal lines from the damage caused by ESD and surge pulses. The devices may be used on lines where the signal polarities are either positive or negative with respect to ground. The MMBZ5V6AL, MMBZ6V2AL, MMBZ6V8AL, MMBZ9V1AL and MMBZ10VAL provide a surge capability of 24 W per line, the MMBZ12VAL, MMBZ15VAL, MMBZ18VAL, MMBZ20VAL, MMBZ27VAL and MMBZ33VAL provide a surge capability of 40 W per line, for a 10/1000 μs waveform.



Tig for Typical application. Lob and transfer voltage proteotion of data

Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

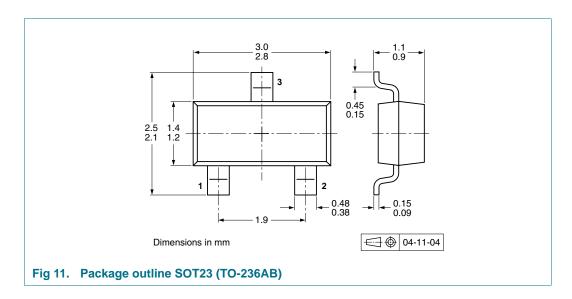
- 1. Place the MMBZxAL series as close to the input terminal or connector as possible.
- 2. The path length between the MMBZxAL series and the protected line should be minimized.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all PCB conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Ground planes should be used whenever possible. For multilayer PCBs, use ground vias

9. Test information

9.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

10. Package outline



11. Packing information

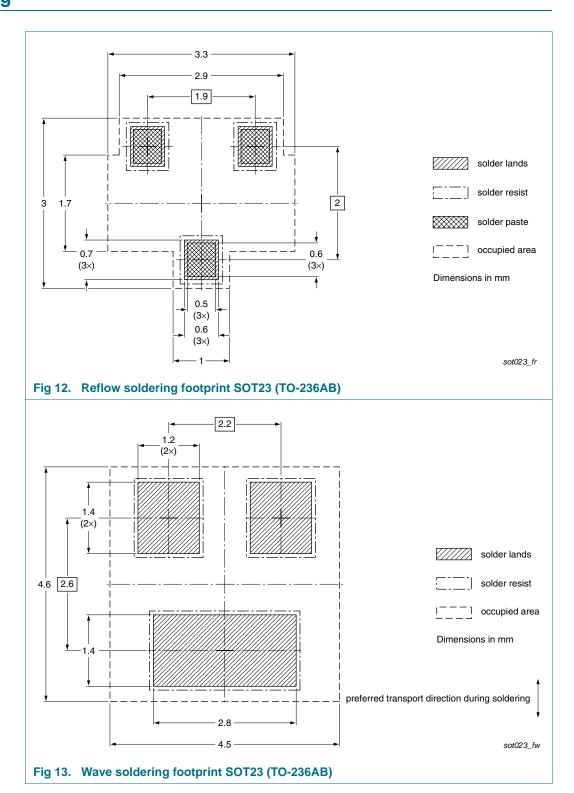
Table 11. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	Packing quantity	
			3000	10000	
MMBZ5V6AL	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235	
MMBZ6V2AL					
MMBZ6V8AL					
MMBZ9V1AL					
MMBZ10VAL					
MMBZ12VAL					
MMBZ15VAL					
MMBZ18VAL					
MMBZ20VAL					
MMBZ27VAL					
MMBZ33VAL					

^[1] For further information and the availability of packing methods, see <u>Section 15</u>.

12. Soldering





13. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
MMBZXAL_SER_2	20091210	Product data sheet	-	MMBZXVAL_SER_1			
Modifications:	 Type numbers MMBZ5V6AL, MMBZ6V2AL, MMBZ6V8AL, MMBZ9V1AL and MMBZ10VAL added 						
	 Type numbers MMBZ12VAL/DG, MMBZ15VAL/DG, MMBZ18VAL/DG, MMBZ20VAL/DG, MMBZ27VAL/DG, MMBZ33VAL/DG removed 						
 <u>Figure 5</u> and <u>7</u>: updated 							
	• Figure 6: added						
	• Figure 10: updated						
	 Section 14 "Legal information": updated 						
MMBZXVAL_SER_1	20080901	Product data sheet	-	-			

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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MMBZxAL series

Low capacitance unidirectional double ESD protection diodes

16. Contents

1	Product profile	. 1
1.1	General description	
1.2	Features	
1.3	Applications	. 1
1.4	Quick reference data	. 2
2	Pinning information	. 2
3	Ordering information	. 3
4	Marking	. 3
5	Limiting values	. 4
6	Thermal characteristics	. 7
7	Characteristics	. 8
8	Application information	12
9	Test information	12
9.1	Quality information	12
10	Package outline	13
11	Packing information	13
12	Soldering	14
13	Revision history	15
14	Legal information	16
14.1	Data sheet status	16
14.2	Definitions	16
14.3	Disclaimers	16
14.4	Trademarks	16
15	Contact information	16
16	Contents	17

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